



## Description

### JMT N-channel Enhancement Mode Power MOSFET

#### Features

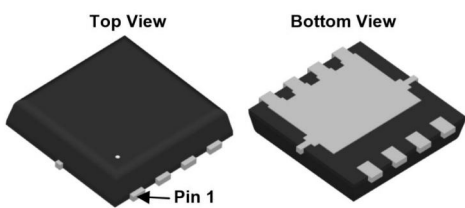
- 40V,50A  
 $R_{DS(ON)} < 6m\Omega @ V_{GS} = 10V$   
 $R_{DS(ON)} < 9m\Omega @ V_{GS} = 4.5V$
- Lead free and Green Device Available
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- Lead free product is acquired

#### Application

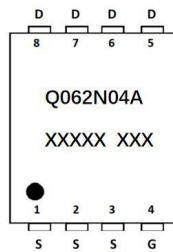
- Load Switch
- PWM Application
- Power management



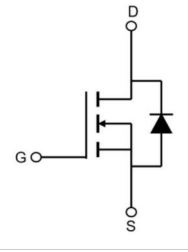
*100% UIS TESTED!*  
*100% ΔVds TESTED!*



PDFN3x3-8L



Marking and pin Assignment



Schematic Diagram

## Package Marking and Ordering Information

| Device Marking | Device      | OUTLINE | Device Package | Reel Size | Reel (PCS) | Per Carton (PCS) |
|----------------|-------------|---------|----------------|-----------|------------|------------------|
| Q062N04A       | JMTQ062N04A | TAPING  | PDFN3x3-8L     | 13inch    | 5000       | 50000            |

## Absolute Maximum Ratings (T<sub>C</sub>=25°C unless otherwise specified)

| Symbol                            | Parameter                                       | Max.                   | Units |
|-----------------------------------|---|------------------------|-------|
| V <sub>DSS</sub>                  | Drain-Source Voltage                            | 40                     | V     |
| V <sub>GSS</sub>                  | Gate-Source Voltage                             | ±20                    | V     |
| I <sub>D</sub>                    | Continuous Drain Current                        | T <sub>C</sub> = 25°C  | 50    |
|                                   |   | T <sub>C</sub> = 100°C | 32.5  |
| I <sub>DM</sub>                   | Pulsed Drain Current <sup>note1</sup>           | 200                    | A     |
| E <sub>AS</sub>                   | Single Pulsed Avalanche Energy <sup>note2</sup> | 56                     | mJ    |
| P <sub>D</sub>                    | Power Dissipation                               | T <sub>C</sub> = 25°C  | 25.5  |
| R <sub>θJC</sub>                  | Thermal Resistance, Junction to Case            | 4.9                    | °C/W  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range         | -55 to +150            | °C    |



## Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise specified)

| Symbol  | Parameter   | Test Condition  | Min. | Typ. | Max. | Units |
|---|---|---|------|------|------|-------|
| <b>Off Characteristic</b>                                     |   |   |      |      |      |       |
| V <sub>(BR)DSS</sub>  | Drain-Source Breakdown Voltage                            | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA  | 40   | -    | -    | V     |
| I <sub>DSS</sub>  | Zero Gate Voltage Drain Current                           | V <sub>DS</sub> =40V, V <sub>GS</sub> =0V,  | -    | -    | 1.0  | μA    |
| I <sub>GSS</sub>  | Gate to Body Leakage Current                              | V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V  | -    | -    | ±100 | nA    |
| <b>On Characteristics</b>                                     |   |   |      |      |      |       |
| V <sub>GS(th)</sub>   | Gate Threshold Voltage                                    | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                                | 1.1  | 1.6  | 2.5  | V     |
| R <sub>DS(on)</sub>   | Static Drain-Source on-Resistance<br><small>note3</small> | V <sub>GS</sub> =10V, I <sub>D</sub> =20A   | -    | 4.5  | 6    | mΩ    |
|   |   | V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A  | -    | 6.5  | 9    |       |
| <b>Dynamic Characteristics</b>                                |   |   |      |      |      |       |
| C <sub>iss</sub>  | Input Capacitance   | V <sub>DS</sub> =20V, V <sub>GS</sub> =0V,<br>f=1.0MHz                                  | -    | 2820 | -    | pF    |
| C <sub>oss</sub>  | Output Capacitance  |   | -    | 241  | -    | pF    |
| C <sub>rss</sub>  | Reverse Transfer Capacitance                              |   | -    | 201  | -    | pF    |
| Q <sub>g</sub>  | Total Gate Charge   | V <sub>DS</sub> =20V, I <sub>D</sub> =20A,<br>V <sub>GS</sub> =10V                      | -    | 20   | -    | nC    |
| Q <sub>gs</sub>   | Gate-Source Charge  |   | -    | 5.5  | -    | nC    |
| Q <sub>gd</sub>   | Gate-Drain("Miller") Charge                               |   | -    | 3    | -    | nC    |
| <b>Switching Characteristics</b>                              |   |   |      |      |      |       |
| t <sub>d(on)</sub>  | Turn-on Delay Time  | V <sub>DS</sub> =20V, R <sub>L</sub> =1Ω,<br>R <sub>GEN</sub> =3Ω, V <sub>GS</sub> =10V | -    | 7.5  | -    | ns    |
| t <sub>r</sub>  | Turn-on Rise Time   |   | -    | 2    | -    | ns    |
| t <sub>d(off)</sub>   | Turn-off Delay Time                                       |   | -    | 23   | -    | ns    |
| t <sub>f</sub>  | Turn-off Fall Time  |   | -    | 3    | -    | ns    |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b> |   |   |      |      |      |       |
| I <sub>S</sub>  | Maximum Continuous Drain to Source Diode Forward Current  |   | -    | -    | 50   | A     |
| I <sub>SM</sub>   | Maximum Pulsed Drain to Source Diode Forward Current      |   | -    | -    | 200  | A     |
| V <sub>SD</sub>   | Drain to Source Diode Forward Voltage                     | V <sub>GS</sub> =0V, I <sub>S</sub> =30A  | -    | -    | 1.2  | V     |
| t <sub>rr</sub>   | Body Diode Reverse Recovery Time                          | I <sub>F</sub> =20A, di/dt=500A/μs  | -    | 11   | -    | ns    |
| Q <sub>rr</sub>   | Body Diode Reverse Recovery Charge                        |   | -    | 21   | -    | nC    |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

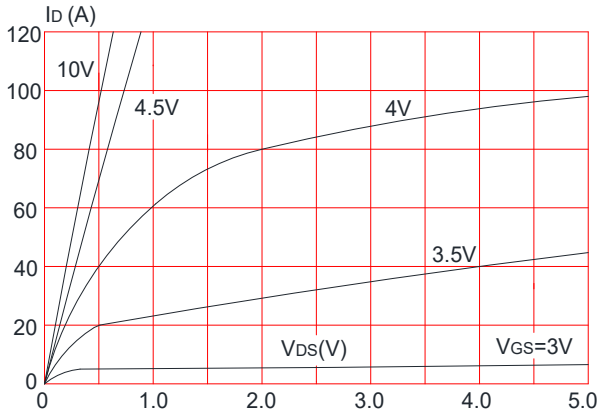
2. EAS condition: T<sub>J</sub>=25°C, V<sub>DD</sub>=20V, V<sub>G</sub>=10V, R<sub>G</sub>=25Ω, L=0.5mH, I<sub>AS</sub>=15A

3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%

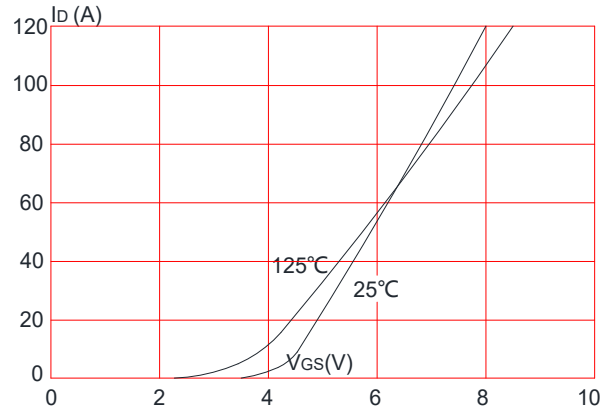


## Typical Performance Characteristics

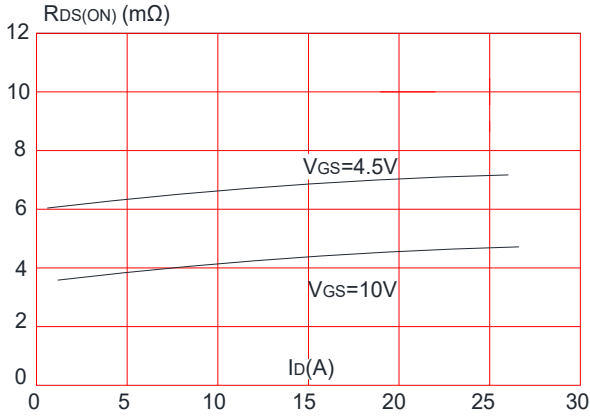
**Figure 1:** Output Characteristics



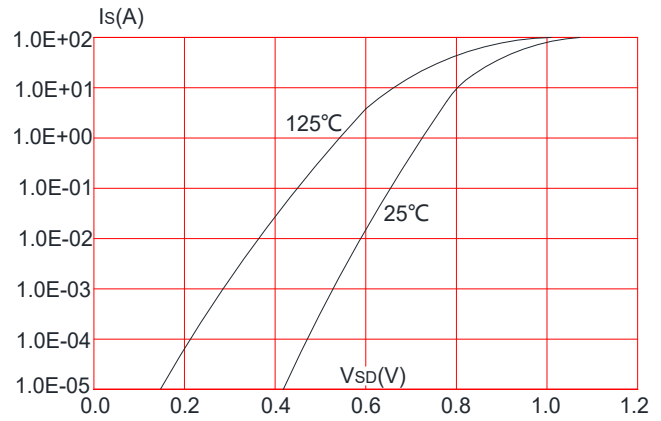
**Figure 2:** Typical Transfer Characteristics



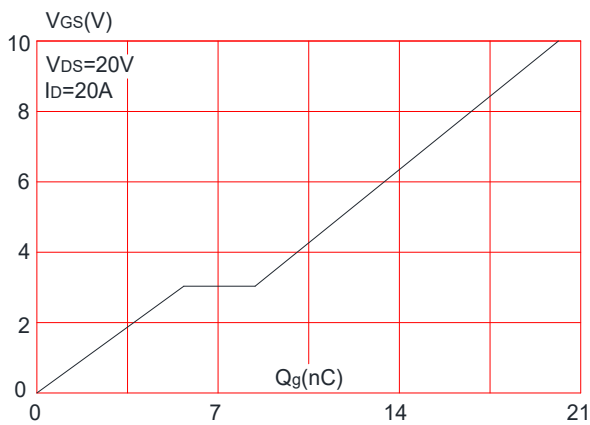
**Figure 3:** On-resistance vs. Drain Current



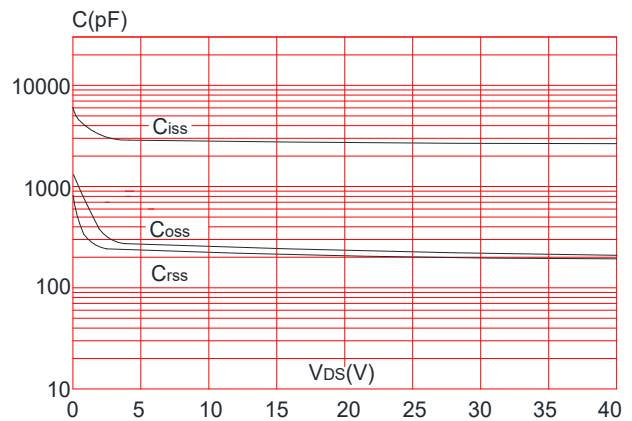
**Figure 4:** Body Diode Characteristics



**Figure 5:** Gate Charge Characteristics



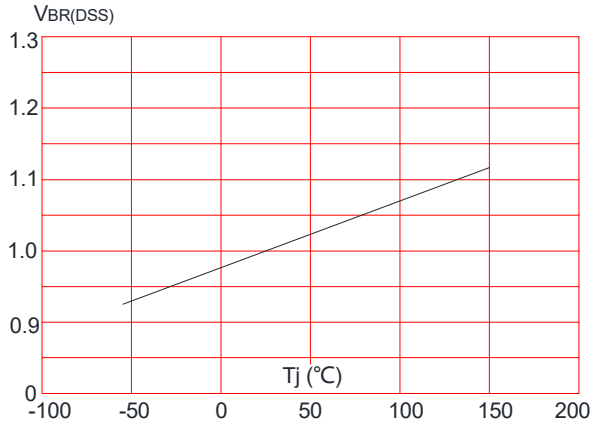
**Figure 6:** Capacitance Characteristics



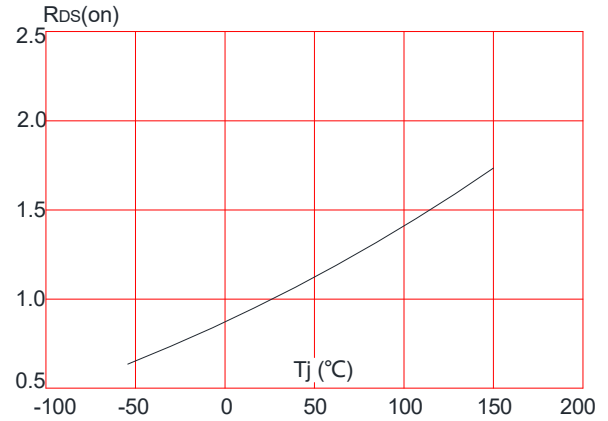


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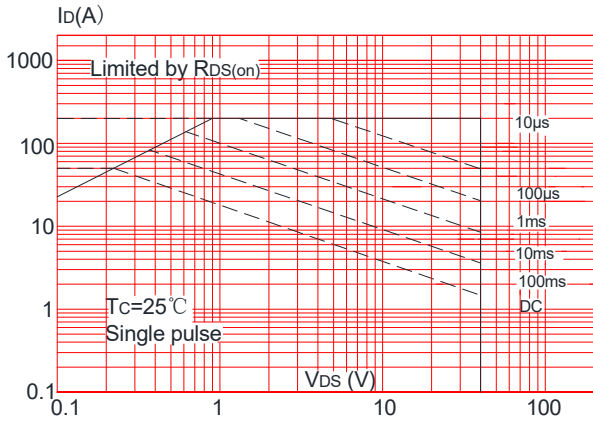
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



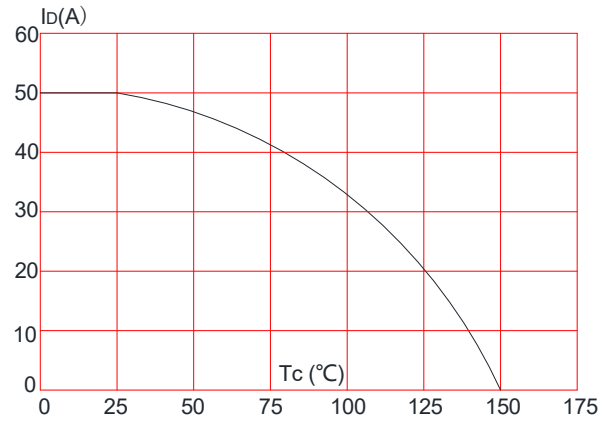
**Figure 8:** Normalized on Resistance vs. Junction Temperature



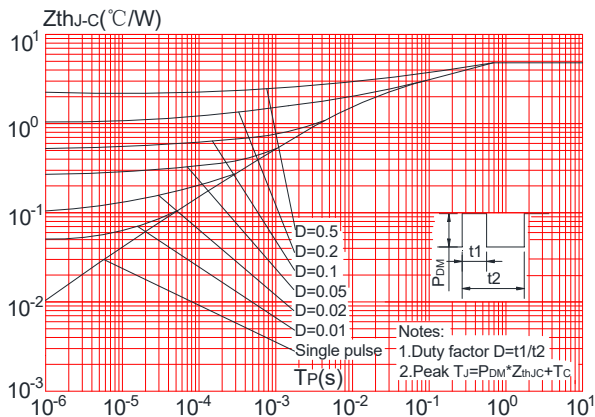
**Figure 9:** Maximum Safe Operating Area



**Figure 10:** Maximum Continuous Drain Current vs. Case Temperature



**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Case



## Test Circuit

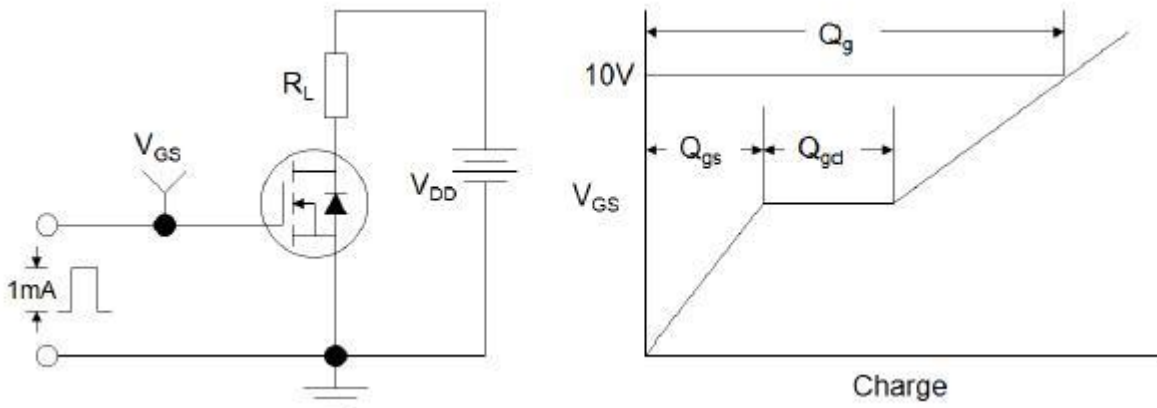


Figure1:Gate Charge Test Circuit & Waveform

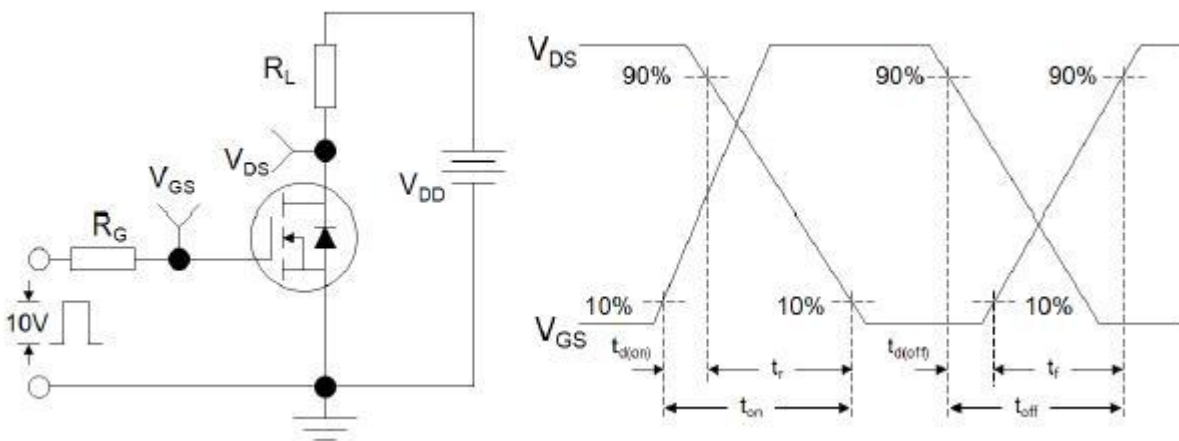


Figure 2: Resistive Switching Test Circuit & Waveforms

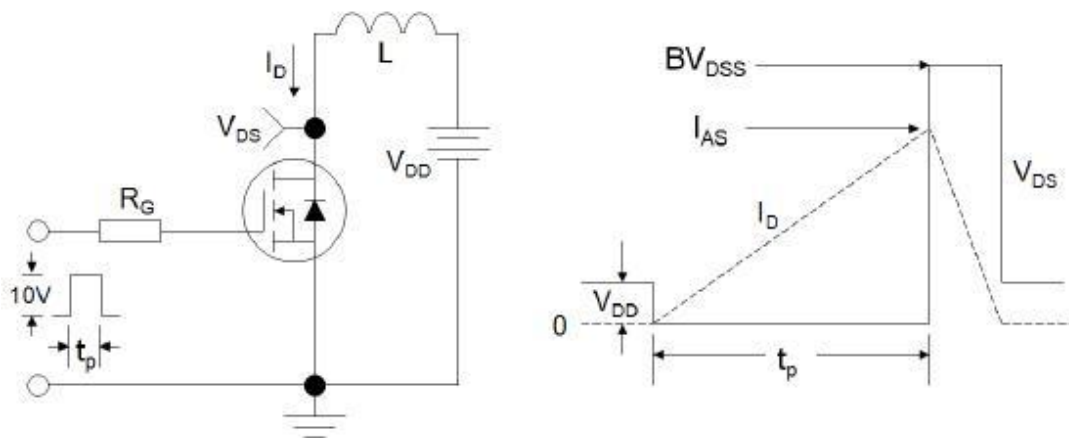
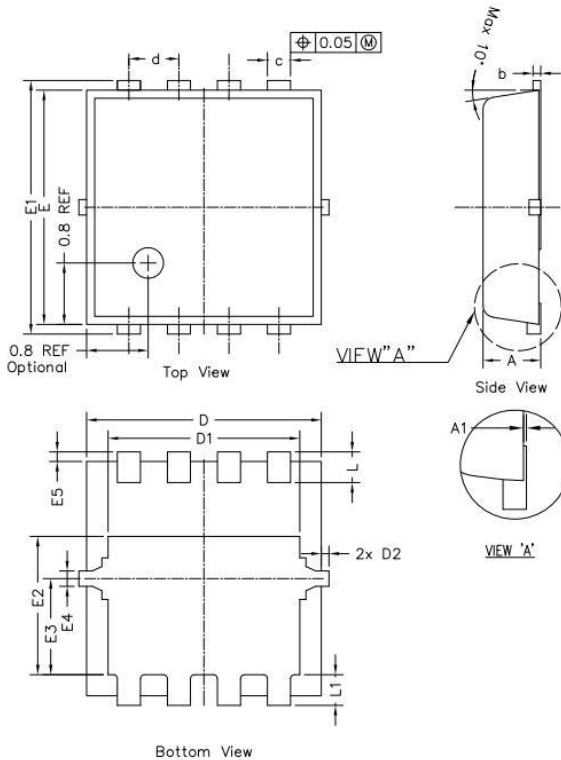


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms



## Package Mechanical Data-PDFN3x3-8L



| SYMBOLS | DIMENSION IN MM |       |       | DIMENSION IN INCHES |       |       |
|---------|-----------------|-------|-------|---------------------|-------|-------|
|         | MIN             | NOM   | MAX   | MIN                 | NOM   | MAX   |
| A       | 0.700           | 0.750 | 0.800 | 0.028               | 0.030 | 0.031 |
| A1      | ---             | ---   | 0.050 | ----                | ----  | 0.002 |
| b       | 0.144           | 0.152 | 0.202 | 0.006               | 0.006 | 0.008 |
| c       | 0.250           | 0.300 | 0.350 | 0.010               | 0.012 | 0.014 |
| d       | 0.65 BSC        |       |       | 0.026 BSC           |       |       |
| D       | 2.950           | 3.050 | 3.150 | 0.116               | 0.120 | 0.124 |
| D1      | 2.390           | 2.490 | 2.590 | 0.094               | 0.098 | 0.102 |
| D2      | ---             | ---   | 0.125 | ---                 | ---   | 0.005 |
| E       | 2.950           | 3.050 | 3.150 | 0.116               | 0.120 | 0.124 |
| E1      | 3.200           | 3.300 | 3.400 | 0.126               | 0.130 | 0.134 |
| E2      | 1.700           | 1.800 | 1.900 | 0.067               | 0.071 | 0.075 |
| E3      | 1.150           | 1.250 | 1.350 | 0.045               | 0.049 | 0.053 |
| E4      | 0.150           | 0.200 | 0.250 | 0.006               | 0.008 | 0.010 |
| E5      | 0.075           | 0.125 | 0.175 | 0.003               | 0.005 | 0.007 |
| L       | 0.300           | 0.400 | 0.500 | 0.01                | 0.02  | 0.02  |
| L1      | 0.300           | 0.400 | 0.500 | 0.01                | 0.02  | 0.02  |

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